AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of the claims in the application:

Listing of the claims:

- 1. (currently amended) An integrated electrofluidic system comprising:
 - a support platform including a plurality of laminated layers:
 - an electronic control system mounted on said support platform;
- a microfluidic system embedded in said platform <u>including</u> and <u>having</u> an input and an output then configured to define and at least one electrofluidic component, the <u>microfluidic system extending an entire length of the platform and</u> configured to circulate a fluid over surfaces of the at least one electrofluidic component and;

at least one electrical conductor carried by said platform for electrically interconnecting said electronic control system and said at least one electrofluidic component.

- 2. (cancelled)
- 3. (original) The integrated electrofluidic system of claim 1 in which said platform includes a polyimide material.
- 4. (original) The integrated electrofluidic system of claim 1 in which said platform includes KAPTON®.

- 5. (original) The integrated electrofluidic system of claim 2 in which said layers are laminated using a phenolic resin adhesive.
- 6. (original) The integrated electrofluidic system of claim 5 in which said phenolic resin adhesive is R/FLEX[®].
- 7. (original) The integrated electrofluidic system of claim 5 in which said phenolic resin adhesive is etched to a thickness of 3 to $10 \, \mu m$.
- 8. (original) The integrated electrofluidic system of claim 5 in which said phenolic resin adhesive is selectively removed from regions where bonding is undesirable between said layers and/or between a said layer and said electrofluidic component and/or a microfluidic component.
- 9. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a valve.
- 10. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a pump.
- 11. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a reservoir.

- 12. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a mixer.
- 13. (original) The integrated electrofluidic system of claim 1 in which said microfluidic system includes at least one channel.
- 14. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a filter.
- 15. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a dispenser.
- 16. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a reactor.
- 17. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a heater.
- 18. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a concentrator.
- 19. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a pressurizing device.

- 20. (withdrawn) The integrated electrofluidic system of claim 1 in which said microfluidic system includes a cooling device.
- 21. (withdrawn) The integrated electrofluidic system of claim 1 further including a sensor device integrated with said microfluidic system.
- 22. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device is embedded in said platform.
- 23. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes a flexure plate wave sensor.
- 24. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes a photoelectric sensor device.
- 25. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes an optical sensor device.
- 26. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes an electrochemical sensor device.
- 27. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes a temperature sensor device.

- 28. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes a pressure sensor device.
- 29. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes a flow sensor device.
- 30. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes a viscosity sensor device.
- 31. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes a mass sensor device.
- 32. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes a magnetic sensor device.
- 33. (withdrawn) The integrated electrofluidic system of claim 21 in which said sensor device includes an acoustic sensor device.
- 34. (withdrawn) The integrated electrofluidic system of claim 1 further including a dispenser device integrated with said microfluidic system.

- 35. (withdrawn) The integrated electrofluidic system of claim 1 further including a heat exchange device integrated with said microfluidic system.
- 36. (withdrawn) The integrated electrofluidic system of claim 34 in which said dispenser device includes a drug delivery device.
- 37. (withdrawn) The integrated electrofluidic system of claim 1 further including a fuel cell device integrated with said microfluidic device.
 - 38. (withdrawn) An integrated electrofluidic system comprising:

a support platform including a plurality of laminated layers each comprised of a polymer material with a thin layer of adhesive;

an electronic control system mounted on said support platform;

a microfluidic system formed by processing said plurality of laminated layers to embed said microfluidic system thereon and for defining at least one electrofluidic component thereon;

an input and an output in fluidic communication with said microfluidic system;

at least one electrofluidic component;

at least one electrical conductor carried by said platform for electrically interconnecting said electronic control system and said at least one electrofluidic component; and

a sensor integrated with said electrofluidic system.

- 39. (withdrawn) The integrated electrofluidic system of claim 38 in which said platform includes a plurality of laminated layers forming said embedded microfluidic system.
 - 40. (withdrawn) An integrated electrofluidic system comprising:
- a support platform including a plurality of laminated layers; each comprised of a polymer material with a thin layer of adhesive;
 - an electronic control system mounted on said support platform;
- a microfluidic system formed by processing said plurality of laminated layers to embed said microfluidic system thereon and for defining at least one electrofluidic component thereon;

an input and an output;

at least one electrofluidic component;

at least one electrical conductor carried by said platform for electrically interconnecting said electronic control system and said at least one electrofluidic component; and

a dispenser device integrated said electrofluidic system.

41. (withdrawn) The integrated electrofluidic system of claim 40 in which said platform includes a plurality of laminated layers forming said embedded microfluidic system.

- 42. (withdrawn) The integrated electrofluidic system of claim 40 in which said dispensing device dispenses fluid in the range of about 100 microliters to 100 picoliters.
- 43. (withdrawn) The integrated electrofluidic system of claim 40 in which said dispensing device dispenses fluid at a rate of about 0.1 to 100 microliters/min.
 - 44. (withdrawn) An integrated electrofluidic system comprising:

a support platform including a plurality of laminated layers; each comprised of a polymer material with a thin layer of adhesive;

an electronic control system mounted on said support platform;

a microfluidic system formed by processing said plurality of laminated layers to embed said microfluidic system thereon and for defining at least one electrofluidic component thereon;

an input and an output;

at least one electrofluidic component;

at least one electrical conductor carried by said platform for electrically interconnecting said electronic control system and said at least one electrofluidic component; and

a heat exchange device integrated with said electrofluidic system.

45. (withdrawn) The integrated electrofluidic system of claim 44 in which said platform includes a plurality of laminated layers forming said embedded microfluidic system.